

Dual N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY

V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A)	Q _g (nC) TYP.
30	0.32 at V _{GS} = 10 V	0.9	1.2
	0.39 at V _{GS} = 4.5 V		

FEATURES

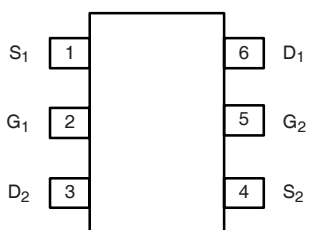
- DT-Trench Power MOSFET
- 100 % R_g tested
- PWM Optimized
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

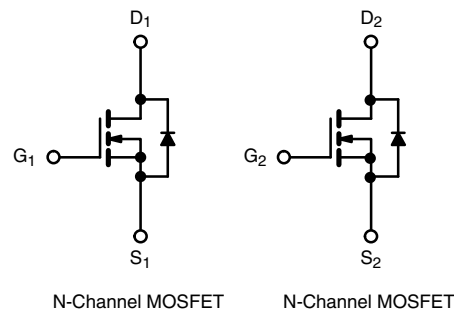
- Level Shifts
- Buck Converters
- Motor drives
- Low power load switch



SOT-323-6



Top View



N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	± 20	
Continuous Drain Current (T _J = 150 °C)	I _D	T _C = 25 °C	A
		T _C = 70 °C	
		T _A = 25 °C	
		T _A = 70 °C	
Pulsed Drain Current	I _{DM}	2.5	A
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	
		T _A = 25 °C	W
Maximum Power Dissipation	P _D	T _C = 25 °C	
		T _C = 70 °C	
		T _A = 25 °C	
		T _A = 70 °C	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient ^{b, d}	R _{thJA}	450	600	°C/W
Maximum Junction-to-Foot (Drain)	R _{thJF}	252	400	

Notes

- Based on T_C = 25 °C.
- Surface mounted on 1" x 1" FR4 board.
- t = 5 s.
- Maximum under steady state conditions is 400 °C/W.

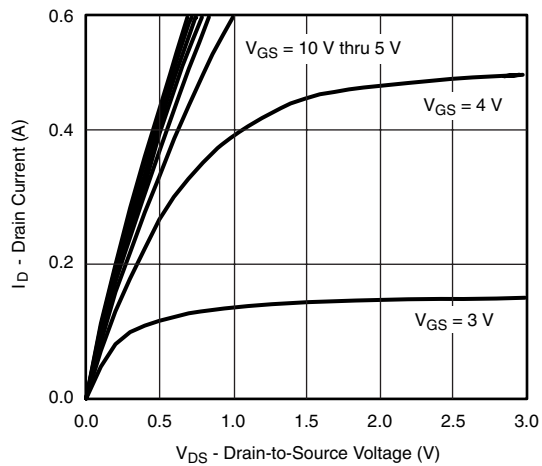
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30			V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA		56.7		mV/°C
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J			-3		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.8		2	V
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 10 V			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1	μA
		V _{DS} = 24 V, V _{GS} = 0 V, T _J = 85 °C			10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	0.9			A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 0.2 A		0.32	0.82	Ω
		V _{GS} = 4.5 V, I _D = 0.2 A		0.39	1.3	
Forward Transconductance	g _{fs}	V _{DS} = 10 V, I _D = 0.2 A		105		ms
Dynamic ^b						
Input Capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		28		pF
Output Capacitance	C _{oss}			16		
Reverse Transfer Capacitance	C _{rss}			7		
Total Gate Charge	Q _g	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 0.2 A		1.2		nC
		V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 0.2 A		0.5		
Gate-Source Charge	Q _{gs}			0.9		
Gate-Drain Charge	Q _{gd}			0.4		
Gate Resistance	R _g	f = 1 MHz		160		Ω
Turn-On Delay Time	t _{d(on)}	V _{DD} = 15 V, R _L = 100 Ω, I _D ≅0.2 A, V _{GEN} = 10 V, R _g = 1 Ω		16		ns
Rise Time	t _r			32		
Turn-Off Delay Time	t _{d(off)}			83		
Fall Time	t _f			74		
Drain-Source Body Diode Characteristics						
Continuous Sorce-Drain Diode Current	I _S	T _C = 25 °C			0.9	A
Pulse Diode Forward Current ^a	I _{SM}				2.5	
Body Diode Voltage	V _{SD}	I _S = 0.2 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 0.2 A, dI/dt = 100 A/μs		26		ns
Body Diode Reverse Recovery Charge	Q _{rr}			23		nC
Reverse Recovery Fall Time	t _a			13.5		ns
Reverse Recovery Rise Time	t _b			3		

Notes

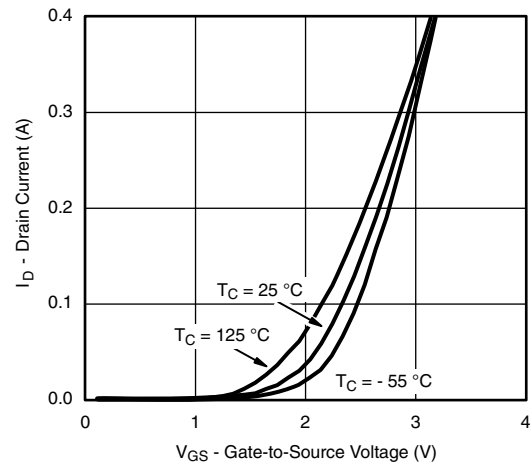
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

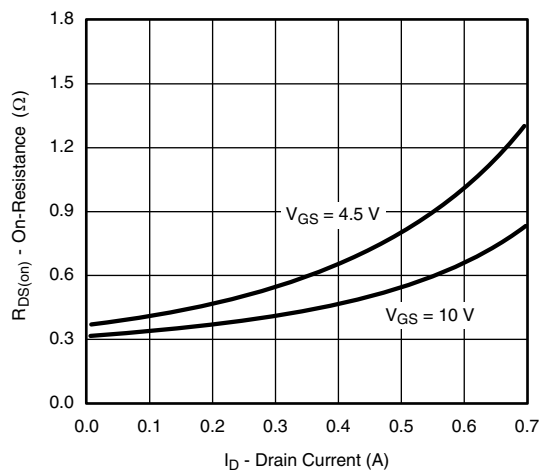
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



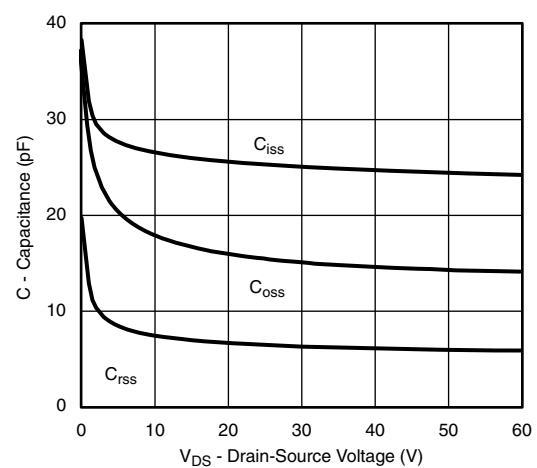
Output Characteristics



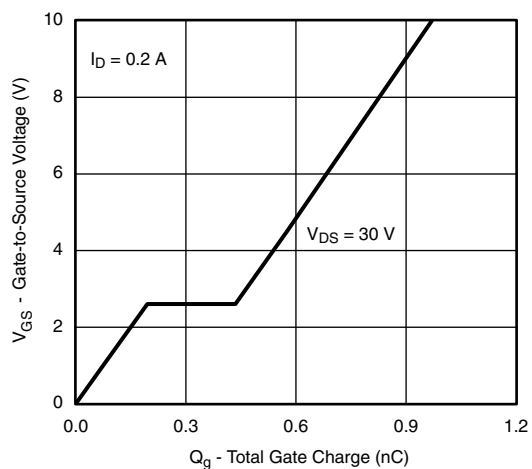
Transfer Characteristics Curves vs. Temperature



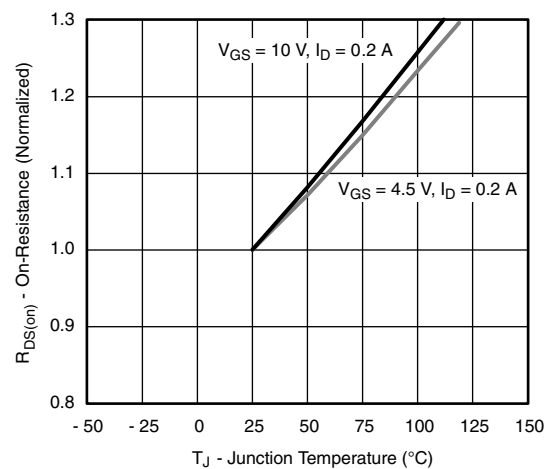
On-Resistance vs. Drain Current



Capacitance

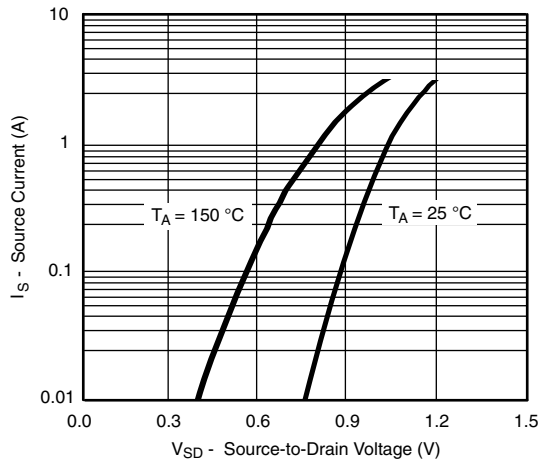


Gate Charge

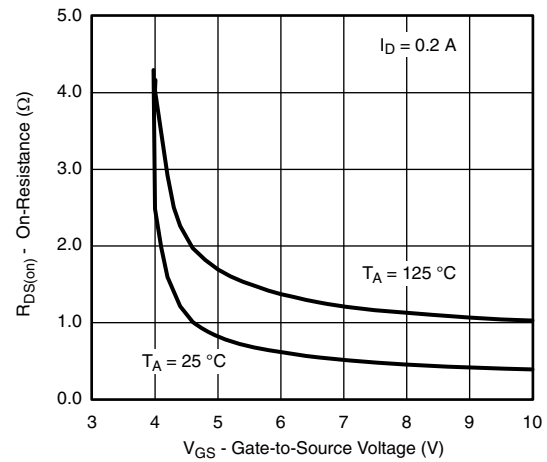


On-Resistance vs. Junction Temperature

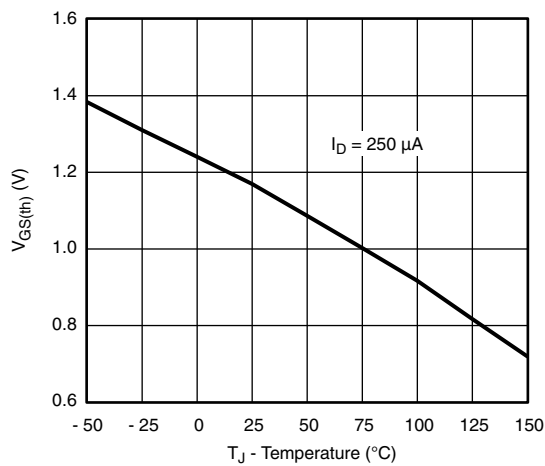
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



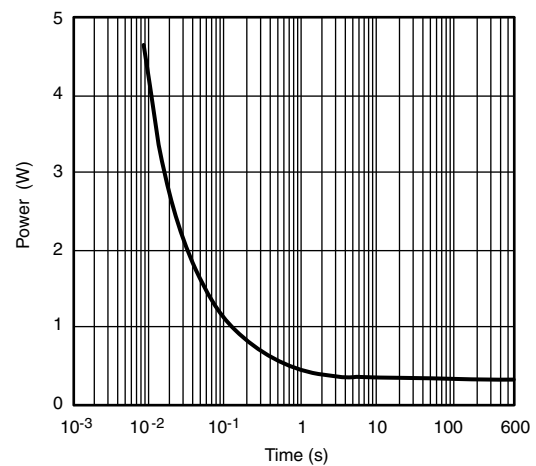
Source-Drain Diode Forward Voltage



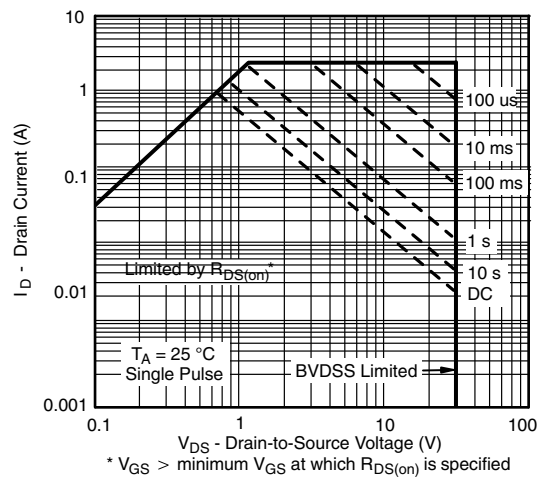
$R_{DS(on)}$ vs. V_{GS} vs. Temperature



Threshold Voltage

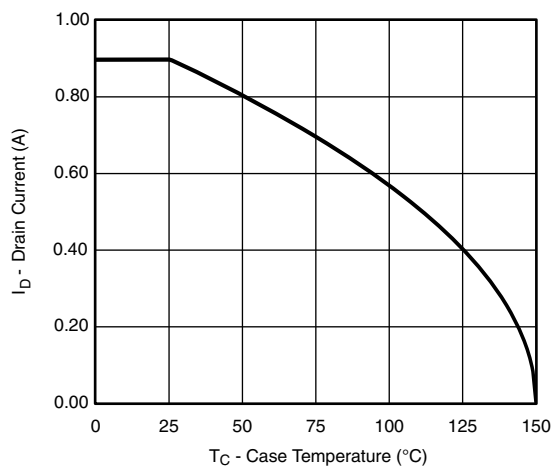


Single Pulse Power

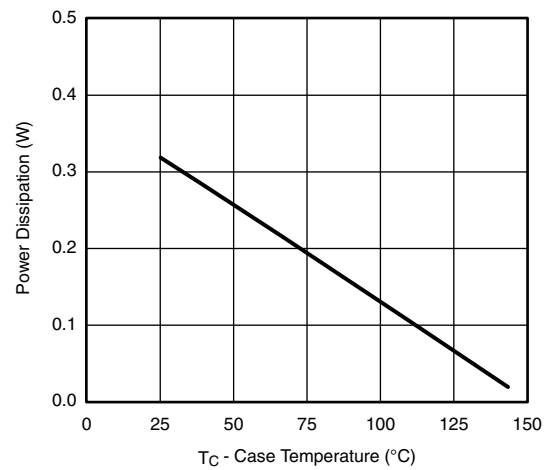


Safe Operating Area

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



Current Derating ^a

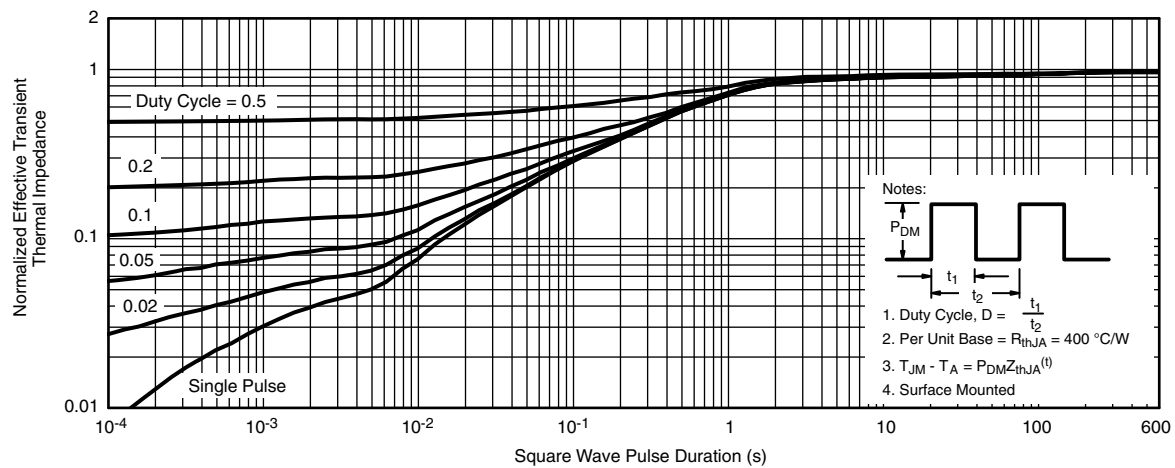


Power Derating

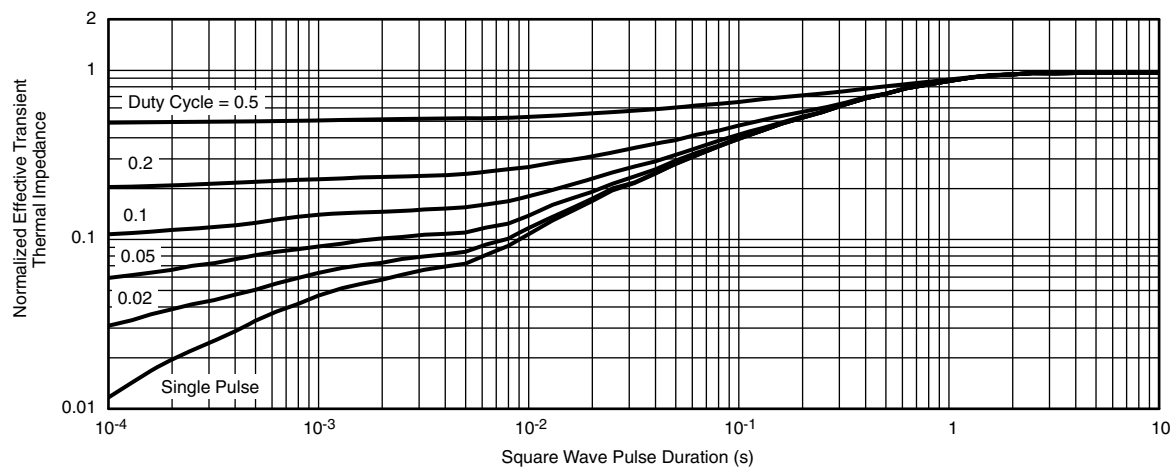
Note

- a. The power dissipation P_D is based on $T_{J(\text{max.})} = 150\text{ }^{\circ}\text{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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